TOSHIBA Photocoupler Photorelay

# **TLP4192G**

# Telecommunication Measurement Equipment Security Equipment FA

The Toshiba TLP4192G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP package. This 1-form-B (NC) photorelay features a withstanding voltage of  $350~\rm V$ .

• 6-pin SOP (2.54SOP6): Height = 2.1 mm, pitch = 2.54 mm

• Normally closed (1-form-B) device

• Peak off-state voltage: 350 V (min)

• Trigger LED current: 3 mA (max)

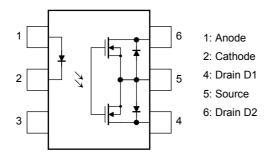
• On-state current: 90 mA (max)

• On-state resistance:  $50 \Omega$  (max)

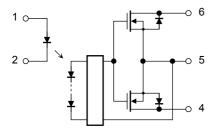
• Isolation voltage: 1500 Vrms (min)

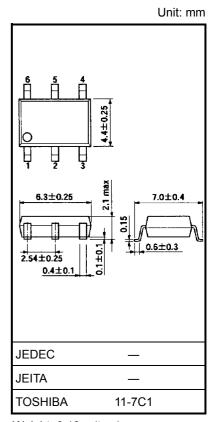
• UL Recognized: UL1577, File No. E67349

#### Pin Configuration (top view)



#### **Schematic**





Weight: 0.13 g (typ.)

# **Maximum Ratings (Ta = 25°C)**

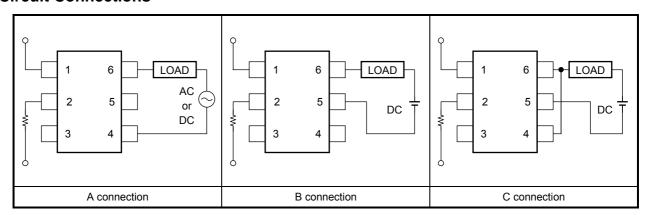
	Characteristics	Symbol	Rating	Unit		
	Forward current	lF	50	mA		
	Forward current derating (Ta	ΔI <sub>F</sub> /°C	-0.5	mA/°C		
LED	Peak forward current (100 μs	s pulse, 100 pps)	I <sub>FP</sub>	1	Α	
	Reverse voltage		V <sub>R</sub>	5	V	
	Junction temperature	Tj	125	°C		
	Off-state output terminal volt	V <sub>OFF</sub>	350	V		
	On-state current	A connection		90		
		B connection	I <sub>ON</sub>	90	mA	
Detector		C connection		180		
Dete	On-state current derating (Ta ≧ 25°C)	A connection		-0.9		
		B connection	Δl <sub>ON</sub> /°C	-0.9	mA/°C	
		C connection		-1.8		
	Junction temperature		Tj	125	°C	
Storage temperature range			T <sub>stg</sub>	-55 to 125	°C	
Operating temperature range			T <sub>opr</sub>	-40 to 85	°C	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C	
Isolation voltage (AC, 1 min, R.H. ≤ 60%) (Note 1)			BVS	1500	Vrms	

Note 1: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

# **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	l <sub>F</sub>	5	_	25	mA
On-state current	I <sub>ON</sub>	_	_	90	mA
Operating temperature	T <sub>opr</sub>	-20		65	°C

#### **Circuit Connections**



# **Electrical Characteristics (Ta = 25°C)**

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
E	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	_	30	_	pF
ctor	Off-state current	l <sub>OFF</sub>	V <sub>OFF</sub> = 350 V, I <sub>F</sub> = 5 mA	_	_	1	μΑ
Detector	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz, I <sub>F</sub> = 5 mA	_	30	_	pF

# **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	_	1	3	mA
Return LED current		I <sub>FT</sub>	I <sub>ON</sub> = 90 mA	0.1	_	_	mA
	A connection		I <sub>ON</sub> = 90 mA	_	27	50	
On-state resistance	B connection	R <sub>ON</sub>	I <sub>ON</sub> = 90 mA	_	20	43	Ω
	C connection		I <sub>ON</sub> = 180 mA	_	10	_	

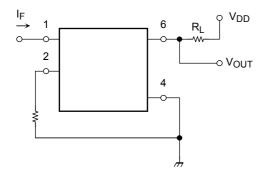
# Isolation Characteristics (Ta = 25°C)

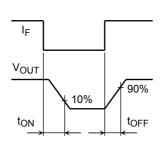
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	$5 \times 10^{10}$	10 <sup>14</sup>	_	Ω
		AC, 1 min	1500	_	_	Vrms
Isolation voltage		AC, 1 s, in oil	_	3000	_	VIIIIS
		DC, 1 min, in oil	_	3000	_	Vdc

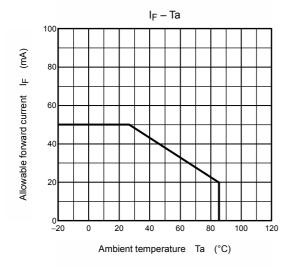
# **Switching Characteristics (Ta = 25°C)**

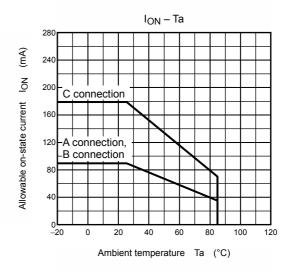
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	$R_L = 200 \Omega$	_	0.25	0.5	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$ (Note 2)		0.5	1	ms

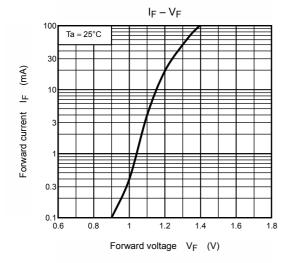
Note 2: Switching time test circuit

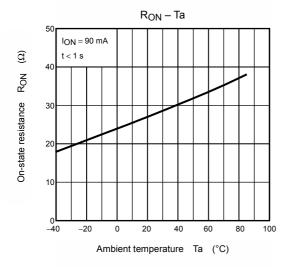


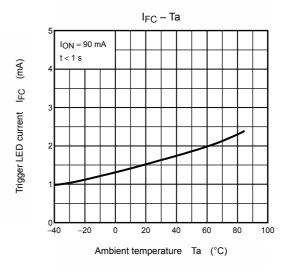


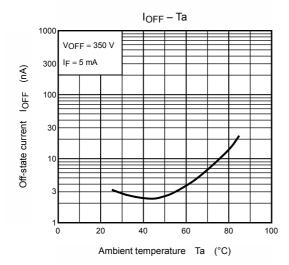


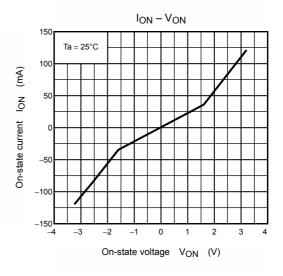


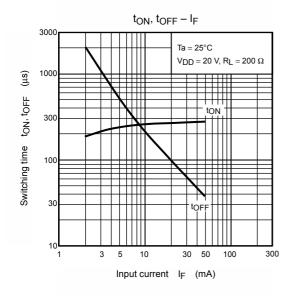


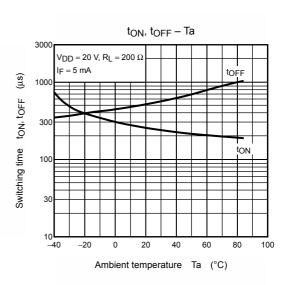












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